

RELIABILITY MONITOR

PRODUCT	MONITOR DATE	DATE CODE	ASSEMBLY FACILITY	ASSEMBLY LOT NO	PROCESS TYPE	PACKAGE TYPE
DS5000T w/CR1620 Bat	Aug-97	9712 D6	DALLAS	DA093587	N/A	40 SBDIP

STRESS/JOB NO.

READPOINT

(Sample Size/No. of Fails)

Hi Temp Storage
70°C, No Bias
P-20252

336 Hr 1KHr
15/0 15/0

Cum %
0.0%

Temp Cycle
0°C to +70°C
P-20253

300 ~ 1000 ~
15/0

Cum %

Moisture Soak
60°C/90% RH
P-20254

288 Hr 960 Hr
15/0 15/0

Cum %
0.0%

Phys. Dimen.
P-20251

Solderability
P-20250

Failure Mode

Failure Analysis